

Series:	SSL1206	
Product Line	Circuit Board Spacer	
Document Date	November 19, 2013	
RoHS Compliant	Yes	
Moisture Sensitivity	MSL 3	

Construction	Homogeneous Material	Material Weight (g)	Homogeneous Material Substances	CAS If Applicable	Material Mass%	Material Mass of Total Unit Wt
Circuit Board	FR-4	2.4172	Phenol, 4,4'-(1-methylethylidene) bis (2,6-dibromo-, polymer with (chloromethyl) oxirane and 4,4'-(1-methylethylidene) bis (phenol)	26265-08-7	33	0.9364
			Copper	7440-50-8	18	
			GF-Fibre	*****	49	
	Solder Mask	0.0168	Bisphenol A, epichlorohydrin polymer	25068-38-6	40	0.0065
			(2-Methoxymethylethoxy) propanol	34590-94-8	10	
			Barium sulphate	7727-43-7	35	
			2-Methyl-1-(4-methylthiophenyl)-2-morpholinopropan-1-one	71868-10-5	10	
			Dipropylene glycol Ethyl ether	15764-24-6	5	
	Solder	0.1070	Sn	7440-31-5	100	0.0414
	Copper	0.0404	Cu	7440-50-8	100	0.0157
Total	2.5814					

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